TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HCT652AP

Octal Bus Transceiver/Register (3-state)

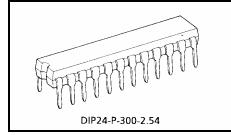
The TC74HCT652A is high speed CMOS OCTAL BUS TRANSCEIVER/REGISTER fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

Its inputs are compatible with TTL, NMOS, and CMOS output voltage levels.

This device is bus transceiver with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the internal registers.

ALL inputs are equipped with protection circuits against static discharge or transient excess voltage.



Weight: 1.50 g (typ.)

Features (Note 1) (Note 2)

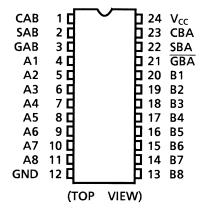
- High speed: $f_{max} = 60 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- Compatible with TTL output: V_{IH} = 2.0 V (min)

$$V_{IL} = 0.8 \text{ V (max)}$$

- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | IOH | = IOL = 6 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Pin and function compatible with 74LS652
 - Note 1: Do not apply a signal to any bus terminal when it is in the out put mode. Damage may result.

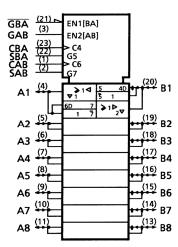
Note 2: All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

Pin Assignment



1 2007-10-01

IEC Logic Symbol



2 2007-10-01

Truth Table

| GAB | GBA | CAB | СВА | SAB | SBA | Α | В | Function |
|------|-----|---------------|-------------|----------|-----|-------------|-------------|--|
| | н | X (Note) | X (Note) | Х | Х | Inputs Z | Inputs Z | The output functions of A and B busses are disabled. |
| L | | | | Х | Х | Х | Х | Both A and B busses are used as inputs to the internal flip-flops. Data on the bus will be stored on the rising edge of the clock. |
| | | Х | Х | | | Inputs | Outputs | |
| | | (Note) | (Note) | L | Х | L | L | The data on the A bus are displayed on the B bus. |
| | | (14010) | (14010) | | | Н | Н | |
| | | _ | X | L | x | L | L | The data on the A bus are displayed on the B bus, and are stored into the A storage flip-flops on the |
| Н | Н | | (Note) | L | ^ | Н | Н | rising edge of CAB. |
| | | X (Note) | X (Note) | н х | | Х | Qn | The data in the A storage flip-flops are displayed on the B bus. |
| | | | X (Note) | | Х | L | L | The data on the A bus are stored into the A |
| | | | | Н | | Н | Н | storage flip-flops on the rising edge of CAB, and the stored data propagate directly onto the B bus. |
| | | × | | х | L | Outputs | Inputs | |
| | | | | | | L | L | The data on the B bus are displayed on the A bus. |
| | | (Note) | | | | Н | Н | |
| | | X L (Note) | | Y | L | L | L | The data on the B bus are displayed on the A bus, |
| L | L | | | × | | Н | Н | and are stored into the B storage flip-flops on the rising edge of CBA. |
| | | Х | Х | Х | Н | 0.5 | Х | The data in the B storage flip-flops are displayed |
| | | (Note) | (Note) | Χ | П | Qn | ^ | on the A bus. |
| | | | | X | Н | L | L | The data on the B bus are stored into the B storage flip-flops on the rising edge of CBA, and |
| | | (Note) | | ^ | П | Н | Н | the stored data propagate directly onto the A bus. |
| Н | L | Х | Х | Н | Н | Outputs | Outputs | The data stored to the internal flip-flops are |
| _ '' | L | (Note) | (Note) | 11 | 11 | Qn | Qn | displayed at the A and B bus respectively. |

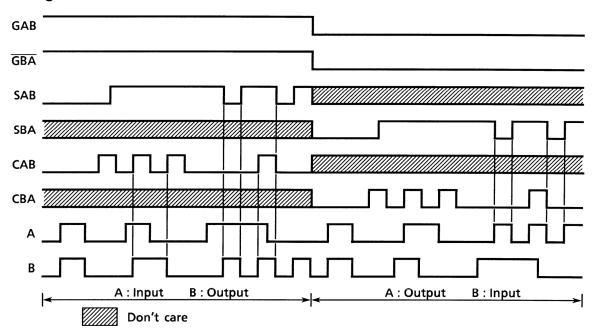
X: Don't care

Qn: The data stored into the internal flip-flops by most recent low to high transition of the clock inputs.

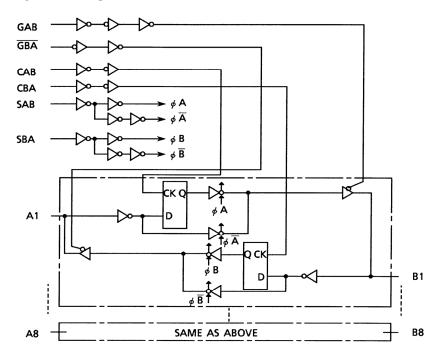
Z: High impedance

Note: The clock are not internally gated with either GAB or $\overline{\text{GBA}}$. Therefore, data on the A and/or B busses may be clocked into the storage flip-flops at any time.

Timing Chart



System Diagram





Absolute Maximum Ratings (Note 1)

| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|----------------------------|------|
| Supply voltage range | V _{CC} | -0.5~7.0 | V |
| DC input voltage | V _{IN} | -0.5~V _{CC} + 0.5 | V |
| DC output voltage | V _{OUT} | -0.5~V _{CC} + 0.5 | V |
| Input diode current | I _{IK} | ±20 | mA |
| Output diode current | lok | ±20 | mA |
| DC output current | l _{OUT} | ±35 | mA |
| DC V _{CC} /ground current | Icc | ±75 | mA |
| Power dissipation | P _D | 500 (DIP) (Note 2) | mW |
| Storage temperature | T _{stg} | -65~150 | °C |

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|--------------------------|---------------------------------|-------------------|------|
| Supply voltage | V _{CC} | 4.5~5.5 | V |
| Input voltage | V _{IN} | 0~V _{CC} | V |
| Output voltage | V _{OUT} | 0~V _{CC} | V |
| Operating temperature | T _{opr} | -40~85 | °C |
| Input rise and fall time | t _r , t _f | 0~500 | ns |

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.



Electrical Characteristics

DC Characteristics

| Characteristics | Symbol | Test Condition | | | ٦ | Га = 25°C | | Ta = -4 | Unit | |
|----------------------------------|-----------------|---|-------------------------|---------------------|------|-----------|------|---------|------|-------|
| Characteristics | Symbol | | | V _{CC} (V) | Min | Тур. | Max | Min | Max | Offic |
| High-level input voltage | V _{IH} | _ | | 4.5~5.5 | 2.0 | _ | _ | 2.0 | | V |
| Low-level input voltage | V _{IL} | _ | | 4.5~5.5 | _ | _ | 0.8 | _ | 0.8 | V |
| High-level output | V _{OH} | V _{IN} = V _{IH} or V _{IL} | $I_{OH} = -20 \mu A$ | 4.5 | 4.4 | 4.5 | _ | 4.4 | _ | V |
| voltage | | | I _{OH} = -6 mA | 4.5 | 4.18 | 4.31 | _ | 4.13 | _ | |
| Low-level output | V _{OL} | VIN = V _{IH} or V _{IL} | $I_{OL} = 20 \ \mu A$ | 4.5 | | 0.0 | 0.1 | _ | 0.1 | V |
| voltage | | | I _{OL} = 6 mA | 4.5 | | 0.17 | 0.26 | _ | 0.33 | V |
| 3-state output off state current | I _{OZ} | $V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND | | 5.5 | l | | ±0.5 | | ±5.0 | μΑ |
| Input leakage current | I _{IN} | V _{IN} = V _{CC} or GND | | 5.5 | | | ±0.1 | _ | ±1.0 | μА |
| Quiescent supply | Icc | V _{IN} = V _{CC} or GND | | 5.5 | | _ | 4.0 | _ | 40.0 | μА |
| current | Ic | Per input: $V_{IN} = 0.5 \text{ V or } 2.4 \text{ V}$ Other input: V_{CC} or GND | | 5.5 | | | 2.0 | _ | 2.9 | mA |

Timing Requirements (input: $t_r = t_f = 6$ ns)

| Characteristics | Symbol | Test Condition | | Ta = | 25°C | Ta = -40 ~85°C | Unit | |
|-----------------------|--------------------|----------------|---------------------|------|-------|----------------------|------|--|
| | | | V _{CC} (V) | Тур. | Limit | Limit | | |
| Minimum pulse width | t _{W (L)} | | 4.5 | _ | 15 | 19 | no | |
| (CK) | t _{W (H)} | _ | 5.5 | _ | 14 | 17 | ns | |
| Minimum act un timo | t _s | | 4.5 | _ | 10 | 13 | 20 | |
| Minimum set-up time | | _ | 5.5 | _ | 9 | 12 | ns | |
| Minimum hold time | | | 4.5 | _ | 5 | 5 | 20 | |
| Willimitati noid time | t _h | _ | 5.5 | _ | 5 | 5 | ns | |
| Clock fraguency | f | | 4.5 | _ | 31 | 25 | MHz | |
| Clock frequency | ļ | | 5.5 | _ | 37 | 30 | | |



AC Characteristics (input: $t_r = t_f = 6$ ns)

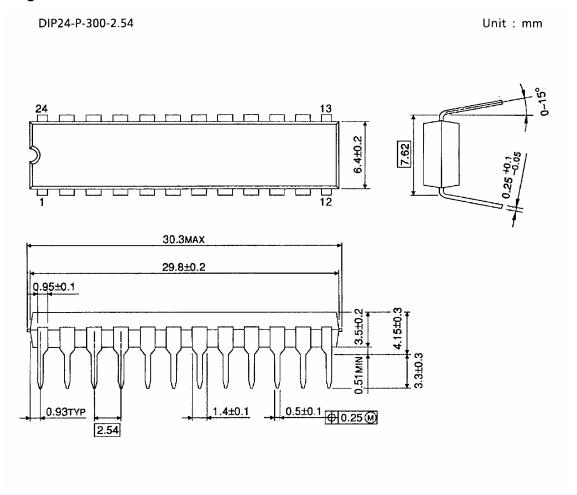
| Characteristics | Symbol | Test Co | ondition | | Ta = 25°C | | | Ta = -4 | Ta = -40~85°C | |
|------------------------|------------------|------------------------------|----------|---------------------|-----------|------|-----|---------|---------------|------|
| Characteristics | Symbol | | CL (pF) | V _{CC} (V) | Min | Тур. | Max | Min | Max | Unit |
| Output transition time | t _{TLH} | | 50 | 4.5 | _ | 7 | 12 | _ | 15 | ns |
| Output transition time | t _{THL} | _ | 50 | 5.5 | _ | 6 | 11 | _ | 14 | |
| | | | 50 | 4.5 | _ | 20 | 30 | _ | 38 | |
| Propagation delay time | t_{pLH} | _ | 30 | 5.5 | _ | 17 | 27 | _ | 34 | ns |
| (BUS-bus) | t_{pHL} | | 150 | 4.5 | _ | 25 | 38 | _ | 48 | 110 |
| | | | 100 | 5.5 | _ | 22 | 34 | _ | 43 | |
| Decree dele | | | 50 | 4.5 | _ | 29 | 44 | _ | 55 | |
| Propagation delay time | t _{pLH} | _ | | 5.5 | _ | 26 | 40 | _ | 50 | ns |
| (CAB, CBA-bus) | t_{pHL} | | 150 | 4.5 | _ | 34 | 52 | _ | 65 | |
| | | | 100 | 5.5 | _ | 31 | 47 | _ | 59 | |
| Decree the delect | t _{pLH} | _ | 50 | 4.5 | _ | 24 | 34 | _ | 43 | - ns |
| Propagation delay time | | | | 5.5 | _ | 21 | 31 | _ | 39 | |
| (SAB, SBA-bus) | t _{pHL} | | 150 | 4.5 | _ | 29 | 42 | _ | 53 | |
| | | | | 5.5 | _ | 26 | 38 | _ | 48 | |
| | | | 50 | 4.5 | _ | 22 | 33 | _ | 41 | ns |
| Output enable time | t_{pZL} | $R_L = 1 k\Omega$ | | 5.5 | _ | 20 | 30 | _ | 37 | |
| (GAB, GBA -bus) | ^t pZH | | 150 | 4.5 | _ | 27 | 41 | _ | 51 | |
| | | | 100 | 5.5 | _ | 24 | 37 | _ | 46 | |
| Output enable time | t_{pLZ} | $R_L = 1 \text{ k}\Omega$ | 50 | 4.5 | _ | 24 | 35 | _ | 44 | ns |
| (GAB, GBA -bus) | t _{pHZ} | | | 5.5 | | 22 | 32 | _ | 40 | |
| Maximum clock | f _{max} | _ | 50 | 4.5 | 31 | 55 | _ | 25 | _ | MHz |
| frequency | ·IIIax | | 50 | 5.5 | 37 | 61 | _ | 30 | _ | |
| Input capacitance | C _{IN} | GAB, GBA, SAB, SBA, CAB, CBA | | _ | 5 | 10 | _ | 10 | pF | |
| Output capacitance | Cout | An, Bn | | | _ | 13 | _ | _ | _ | pF |
| Power dissipation | C_{PD} | _ | _ | | _ | _ 39 | | | | pF |
| capacitance | (Note) | | | | | | | | | ۲. |

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per bit)

Package Dimensions



Weight: 1.50 g (typ.)

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20070701-EN GENERAL

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